

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	2717	257/777	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 11:31
2	L2	2926	257/686	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:42
3	L3	671960	chip	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:43
4	L4	536216	pad	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:43
5	L5	1495303	insulat\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:43
6	L6	2503625	conduct\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44
7	L7	2128	257/780	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44
8	L8	6113	1 or 2 or 7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44
9	L9	63326	3 same 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44
10	L10	9891	5 same 9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44
11	L11	4629	6 same 10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:44

	L #	Hits	Search Text	DBs	Time Stamp
12	L12	6318894	side	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:45
13	L13	1232	11 same 12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:45
14	L14	57	7 and 13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:52
15	L15	192	8 and 13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:52
16	L16	135	15 not 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 12:52